Thermoelectric properties of semimetals

Maxime Markov,^{1,*} S. Emad Rezaei,¹ Safoura Nayeb Sadeghi,² Keivan Esfarjani,^{2,3,4} and Mona Zebarjadi^{1,4,†}

¹Department of Electrical and Computer Engineering, University of Virginia, Charlottesville, Virginia 22904, USA

²Department of Mechanical and Aerospace Engineering, University of Virginia, Charlottesville, Virginia 22904, USA

⁴Department of Materials Science and Engineering, University of Virginia, Charlottesville, Virginia 22904, USA

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Heavily doped semiconductors are by far the most studied class of materials for thermoelectric applications in the past several decades. They have Seebeck coefficient values which are 2–3 orders of magnitude higher than metals, making them attractive for thermoelectric applications. Conventional wisdom suggests that the optimal band gap of a semiconductor to achieve the largest power factor should be between 6 and 10 k_BT , yet the highest power factor materials known up to now do not have a band gap. In this paper, we show that semimetals with very small or no band gap, but high asymmetry between their conduction and valence bands, can also have large Seebeck coefficient values on the order of 200 μ V/K, which is near the optimum value for thermoelectric applications. We have studied the band structure of a class of 18 semimetals using first principles calculations and calculated their Seebeck coefficient using the linearized Boltzmann equation within the constant relaxation time approximation. We conclude that despite the absence of the band gap, semimetals with band asymmetry can have good thermoelectric performance. We analyze the metrics often used to describe thermoelectric properties of materials and show that the ratio of electron and hole mass of density of states is a key parameter resulting in high Seebeck coefficient values in semimetals. This work is therefore suggesting some high thermoelectric performance materials could be of semimetallic nature.

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I. INTRODUCTION

Material thermoelectric figure of merit zT is defined as $zT = \frac{\sigma S^2 T}{\kappa}$, wherein σ is the electrical conductivity, *S* is the Seebeck coefficient, κ is the thermal conductivity, and *T* is the temperature. A thermoelectric module is made out of n and p legs electrically in series and thermally in parallel. The efficiency of a thermoelectric module in power generation mode [1] and in refrigeration cycle [2], and the thermal switching ratio in switching mode [3], are increasing functions of the n and p materials' figure of merit. Hence, finding thermoelectric materials with large figure of merit is of high interest.

Metals were the first class of materials studied for thermoelectric applications. While they have large electrical conductivity, they usually have small Seebeck coefficient values and large thermal conductivity values, making them nonideal candidates for traditional thermoelectric applications. Semiconductors usually own Seebeck coefficient values that are orders of magnitude larger than metals. The large Seebeck coefficient is the result of the presence of the band gap which breaks the symmetry between electrons and holes. There are two major competing factors in optimization of the figure of merit in semiconductors. First, when the Fermi level is inside the band gap, the Seebeck coefficient is large. As the Fermi level moves into the valence or conduction bands, the difference between the density of states (DOS) of hot electrons (above the Fermi level) and cold electrons (below the Fermi level) becomes small and so does the Seebeck coefficient. On the contrary, the electrical conductivity increases since there are more available electronic states. As a result, one needs to adjust the position of the Fermi level to optimize the thermoelectric power factor, $P = \sigma S^2$. Second, as the Fermi level moves inside the band, similar to the electrical conductivity, the electronic part of the thermal conductivity also increases. It is therefore difficult to design a material with very large figure of merit although no theoretical upper limit has been found for zT.

Semimetals are a class of materials with properties in between semiconductors and metals. They usually have a very small overlap of bands and therefore while they do not have an energy gap, their intrinsic carrier density can vary in a large range, between 10^{15} – 10^{20} cm⁻³, depending on the band overlap and the size of the carrier pockets. For example, the intrinsic concentrations at liquid helium temperature 4.2 K are about 5.0×10^{15} cm⁻³ for HgTe [21], 3.6×10^{16} cm⁻³ for HgSe [22], 2.7×10^{17} cm⁻³ for Bi [23], 3.7×10^{19} cm⁻³ for Sb [23], and 2.0×10^{20} cm⁻³ for As [23]. These values are much smaller than in metals, which are typically around 10^{23} cm⁻³, and are comparable with and in some cases smaller than in heavily-doped semiconductors used for thermoelectric applications, 10^{18} – 10^{20} cm⁻³. However, semimetals generally have much larger carrier mobility values compared to metals and heavily doped semiconductors. For example, electron mobilities at 4.2 K are 6.0×10^5 cm² V⁻¹ s⁻¹ in HgTe [21], $1.2 \times$ $10^5 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ in HgSe [24,25], and $11 \times 10^7 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$

³Department of Physics, University of Virginia, Charlottesville, Virginia 22904, USA

^{*}Present address: UCLouvain, Institut de la Matière Condensé et des Nanosciences (IMCN), Chemin des Étoiles 8, Louvain-la-Neuve 1348, Belgium.

[†]m.zebarjadi@virginia.edu

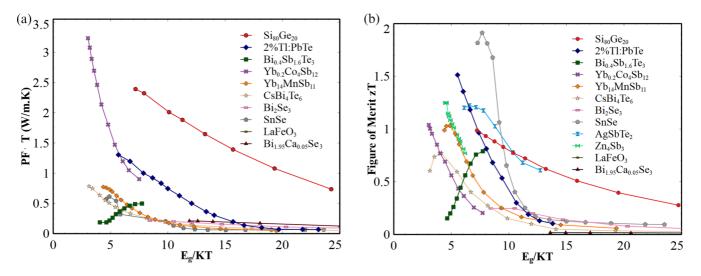


FIG. 1. Thermoelectric power factor \times T (a) and figure of merit, zT, (b) versus band gap of a few p-type semiconductors reported in previous studies including Si₂₀Ge₈₀ [4], Bi₂Te₃ [5], PbTe [6], Skutterudite Yb_{0.2}Co₄Sb₁₂ [7], Yb₁₄MnSb₁₁ [8], LaFeO₃ [9], CsBi₄Te₆ [10], Bi₂Se₃ [11], SnSe [12], Bi_{1.95}Ca_{0.05}Te₃ [11], AgSbTe₂ [13], Bi_{0.4}Sb_{1.6}Te₃ [14], and Zn₄Sb₃ [15]. Note that with the exception of Bi_{0.4}Sb_{1.6}Te₃ and SnSe the power factor curves have an increasing trend as the band gap is decreased, implying the optimum point for these well-known thermoelectrics occurs at smaller band gaps than previously expected. Band gap values at room temperature in eV are 0.08 for CsBi₄Te₆ [10], 0.50 for Yb₁₄MnSb₁₁ [8], 0.35 for AgSbTe₂ [13], 0.30 for Bi_{1.95}Ca_{0.05}Te₃ [11], 0.61 for SnSe [12], 1.05 for Si₂₀Ge₈₀ [16], 2.52 for LaFeO₃ [9], 0.36 for PbTe [17], 0.22 for Bi₂Se₃ [18], 1.20 for Zn₄Sb₃ [19], 0.20 for Bi_{0.4}Sb_{1.6}Te₃ [20], and 0.197 for Yb_{0.2}Co₄Sb₁₂ [7]. Band gap values are assumed to be constant versus temperature.

in Bi [23] and at room temperature are 3.5×10^4 cm² V⁻¹ s⁻¹ in HgTe [26], 2.0×10^4 cm² V⁻¹ s⁻¹ in HgSe [27,28], and 1.2×10^4 cm² V⁻¹ s⁻¹ in Bi [29]. As a result, the electrical conductivity of semimetals is comparable to those of heavily-doped semiconductors. Note that the carrier mobility is much lower in heavily-doped semiconductors due to ionized impurity doping and in metals due to electron-electron and electron-phonon interactions. The thermal conductivity values in semimetals could be also small, especially if they consist of heavy elements. For example, the thermal conductivity at room temperature is about 1.7 W m⁻¹ K⁻¹ in HgSe [30], 1.9-2.9 W m⁻¹ K⁻¹ in HgTe [30,31], 6.0 W m⁻¹ K⁻¹ in the trigonal direction in pure bismuth [32–34], and could be as low as 1.6 W m⁻¹ K⁻¹ in Bi-Sb alloys [33,35].

Semimetallic and zero gap materials show many interesting properties. They have attracted interests as topologically nontrivial materials [36]. Many of them have strong spin-orbit coupling and are comprised of heavy elements. As a result, they possess a low thermal conductivity. Inversion of bands happens in many of the zero-gap alloys such as Bi_xSb_{1-x} [37] and $Hg_xCd_{1-x}Te$ [38], leading to interesting transport properties. While many of these materials have been studied in other fields, there has not been a systematic study of their thermoelectric properties due to their lack of band gap.

If one is to avoid doping and only choose to work with intrinsic materials, semimetals would be the best potential candidate for having a large thermoelectric power factor [39]. This motivates our hypothesis that zero or small band-gap materials have the potential of being good thermoelectrics with high power factor PF and zT.

In our recent publication, we studied thermoelectric properties of HgTe [31] as a well-known semimetal. One of the interesting features observed was that the Seebeck coefficient in intrinsic HgTe was not sensitive to the number of defects and impurities inside the sample. This means one can change the carrier concentration by orders of magnitude while keeping the Seebeck coefficient constant. This is because these large changes in carrier concentration did not result in a considerable shift in the chemical potential, so that Seebeck was not changed. If this is a general trend in semimetals, then the interplay between electrical conductivity and Seebeck coefficient is much weaker in semimetals compared to semiconductors and therefore it is easier to increase the figure of merit in semimetallic samples. Semimetals are especially promising for low temperature applications (below ambient) where the dominant source of scattering is impurity scattering where heavily doped semiconductors suffer from low mobility. Additionally, as can be noted in Fig. 1, in many good thermoelectric semiconductors, the optimized zT and power factor values were found to keep increasing as the band gap to temperature ratio is decreased [40]. This motivates our hypothesis, which we would like to validate, on zero or small band-gap materials having the potential of being good thermoelectrics with high power factor PF and zT.

In this work, the thermoelectric response of several semimetallic elements, i.e., their Seebeck coefficient values, are studied using first principles calculations with proper corrections for the energy levels. We restrict ourselves to room temperature where the diffusive part of the Seebeck coefficient is known to be dominant. The rationale to focus only on the Seebeck coefficient is the following: As was discussed, the carrier mobility is expected to be large in semimetals. If semimetals consist of heavy elements, then their thermal conductivity is also expected to be low. The biggest concern with semimetals is therefore the Seebeck coefficient and thus the process of searching for good semimetals for

Material	Crystal	Group No.	Natoms	$E_g (eV)$ PBE	E_g (eV) HSE/mBJ	m_h^*/m_e^* PBE	m_h^*/m_e^* HSE/mBJ
НдТе	cubic	216	2	-0.019	-0.009	3.71	16.29
HgSe	cubic	216	2	-0.018	-0.009	10.34	17.63
HgS	cubic	216	2	0.038	0.305	19.63	25.45
TIP	cubic	216	2	-0.018	0.000	2.52	18.18
TlAs	cubic	216	2	-0.019	-0.009	3.28	1.58
Li ₂ AgSb	cubic	216	2	-0.009	0.676	0.02	0.08
Na ₂ AgSb	cubic	216	2	-0.009	0.000	34.59	51.50
Rb ₂ AgSb	cubic	216	2	-0.020	-0.008	2.51	56.84
α-Sn	cubic	227	2	-0.031	-0.030	0.171	0.30
Bi	trigonal	166	2	-0.122	-0.061	1.711	5.87
Sb	trigonal	166	2	-0.09	-0.039	7.22	1.28
TaAs	tetragonal	109	4	0.062	-0.003	13.92	3.73
TaP	tetragonal	109	4	-0.15	-0.092	1.81	0.13
NbP	tetragonal	109	4	-0.152	0.061	0.07	0.25
Mg ₂ Pb	cubic	225	3	-0.793	-0.427	0.12	0.11
PtSb ₂	cubic	205	12	-0.110	-0.083	0.69	0.48
TiS ₂	trigonal	164	3	-0.226	0.396	0.13	0.24
TiSe ₂	trigonal	164	3	-0.623	-0.346	N/A	N/A

TABLE I. Summary of 18 materials studied in this work including their crystal structure, space group number, number of atoms per unit cell, band gap in PBE and HSE calculations, as well as ratio of hole effective mass to electron effective mass.

thermoelectric applications should start with the scan for the Seebeck coefficient. From a computational point of view, among the three transport properties determining the figure of merit, the Seebeck coefficient is the least sensitive one to the scattering rates. Therefore, the only property that could be reliably calculated under constant relaxation time approximation and still be of value is the Seebeck coefficient. We should acknowledge that even Seebeck coefficient values can be modified when energy dependent relaxation times are introduced [31,41–43]. Including energy dependent relaxation times would be a very difficult task when scanning many materials. Here, as the first step towards finding promising semimetallic candidates, we limit ourselves to the constant relaxation time approximation.

II. COMPUTATIONAL METHODS

We preselect 18 materials which were mentioned in the literature as semimetals. Information about their crystal structure, space group number, and number of atoms per unit cell are summarized in Table I. Vienna ab initio simulation package (VASP) [44,45] is used to perform first-principles calculations. Pseudopotentials based on the projector augmented wave method [46] from the VASP library with the generalized gradient approximation by Perdew, Burke, and Ernzehof (GGA-PBE) [47] as well as hybrid Heyd-Scuseria-Ernzehof (HSE06) [48] exchange-correlation (XC) functionals are employed to calculate band structure and density of states. Since the Seebeck coefficient is very sensitive to the band gap and effective masses, and the latter strongly depend on the choice of the XC functional, one has to be aware that depending on the choice of the functional, one will end up with a range of Seebeck values. For our purposes, we chose the hybrid HSE functional which has been widely used in the literature [38,49-52] to describe the electronic structure properties with an accuracy comparable with that of the GW method. To get some idea about the range of these predictions, we also compared HSE predictions to the more conventional, but not as accurate, PBE ones. The details about the cutoff energy and number of k points may be found in the Supplemental Material [53]. We used relaxed PBE lattice parameters for all materials but HgTe, HgSe, and HgS. For the latter three materials the experimental lattice parameters [54,55] were considered. The summary of the lattice parameters can be found in the Supplemental Material. Spin-orbit coupling is included in all calculations (except for TiS_2 and $TiSe_2$) and transport calculations are performed within the constant relaxation time approximation (CRTA) as implemented in BoltzTraP [56,57] and BoltzWann [58] codes to obtain the diffusive part of the Seebeck coefficient (see Table 1 of the Supplemental Material). The interpolating k point grid was taken to be at least 30 times denser than the initial DFT grid.

III. RESULTS

We divide all semimetals into three separate groups. These are shown schematically in Fig. 2. The first group possesses a distinct feature in the band structure: The lowest conduction band has a deep minimum at the center of the Brillouin zone (BZ) where it overlaps with the highest valence bands. When the two bands are symmetric (shown by black curves), the intrinsic chemical potential is expected to be at the midpoint between the two band extrema, and the intrinsic Seebeck coefficient is expected to be very small. However, it is possible to have a band structure similar to the red curve in Fig. 2(a), where the low degeneracy of the conduction band in the vicinity of the Γ point results in a small density-of-states (DOS), the magnitude of which is essentially defined by the electron's effective mass (i.e., the curvature of the band). On the other hand, valence bands have heavier effective masses and higher degeneracy with contributions from elsewhere in

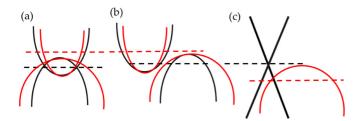


FIG. 2. Schematic illustration of different types of semimetals: (a) direct semimetal with parabolic bands, (b) indirect semimetal with parabolic bands, (c) Dirac or Weyl semimetal with linear dispersion. The Fermi level is denoted by the dashed line. In each case, the band structure could be symmetric as shown by black curves or asymmetric as shown by red curves. Semimetals with asymmetric bands are the focus of this work.

the BZ. As a result, the DOS is asymmetric about the chemical potential. This is known to be beneficial for the material's electronic properties in general and, in particular, leads to a high Seebeck coefficient. A typical example of such material is HgTe which has been studied in our recent publication both theoretically and experimentally [31]. Other (predominantly cubic) materials are HgSe and HgS, TlAs and TlP [59], α -Sn as well as inverse Heusler materials (Li₂AgSb, Na₂AgSb), Rb₂AgSb) [59,60]. The band structures of these materials along with their DOS are shown in the Supplemental Material. Here, as the representative of this class of materials, we show the band structure and the DOS of HgTe as shown in Fig. 3(a). Black curves are used to show PBE results for the band structure and the DOS of all materials reported in this work. Red curves show the HSE results.

Among the materials studied within the first class, the hybrid functional calculations (red curves) reveal that HgS and Li₂AgSb are in fact semiconductors with band gaps of 0.33 eV and 0.67 eV, respectively. In almost all cases, we note that the effective masses of the conduction band significantly decreases in HSE compared with PBE calculations. A possible explanation for this effect has been given in Ref. [49] where the small effective masses were attributed to the strong level repulsion between the s-like conduction band and p-like valence band at Γ . This repulsion is inversely proportional to the square of the difference between these two levels [49] which reduces from -0.93 eV for PBE to -0.27 eV for HSE06 in the case of HgTe [31,38].

The second group [Fig. 3(b)] includes other semimetallic materials without any distinct feature in their band structure but possessing a low density of states at the Fermi level. The top of the valence band and the bottom of the conduction band are at different k points as shown schematically in Fig. 2(b). Electron and hole pockets coexist. This class includes, for instance, Mg₂Pb, cubic pyrite structures (PtSb₂ and PtBi₂) [61–63], TiS₂, TiSe₂, TaP, NbP, and α -Zn₃Sb₂ [64]. We note that a TiS_2 gap opens up when the HSE functional is used and therefore this material is a semiconductor with the band gap of 0.4 eV. Despite its large Seebeck coefficient which is expected for a material with a band gap, the intrinsic carrier concentration is low and therefore it does not fall in the class of materials we are interested in this work. On the other hand, TiSe₂ remains semimetallic under HSE, with overlapping conduction (L and M points) and valence bands (Γ point). Its Seebeck coefficient is however found to be small due to the small asymmetry in the bands. In another work where properties of the monolayer $TiSe_2$ were studied [65], we found that the band gap can be opened under tensile strain, leading to a metal-insulator transition and corresponding nonlinear effects. As for Mg₂Pb, the overlap of bands is relatively large and the ratio of the DOS effective mass of the conduction band to that of the valence band is close to one. (see Fig. 3(b)Therefore this material exhibits a small intrinsic Seebeck coefficient value of about $-10 \mu V/K$.

The third class of materials includes relativistic (Dirac and Weyl) semimetals with linear bands close to the Fermi level. These are schematically shown in Fig. 2(c). The examples include Bi, Sb, Na₃Bi and TaAs-family and inverse Heusler materials Na₂AgSb and Rb₂AgSb. Thermoelectric properties of the latter family as well as some other topologically non-trivial semimetals have been recently investigated in Ref. [36]. The band structure of Bi as the representative of this class of materials is shown in Fig. 3(c). Most samples in this group demonstrate rather small Seebeck coefficient values. This is expected because there is an inherent symmetry in the band structure at the Dirac point.

The symmetry can break down only if additional bands exist close to the Dirac point as shown schematically in Fig. 2(c). Two examples are Na₂AgSb and Rb₂AgSb which show, within HSE, a Dirac dispersion at the Γ point, in addition to a parabolic valence band. The band structure, the DOS, and the corresponding Seebeck coefficient of these two materials are shown in Fig. 4. The Seebeck is only reported for HSE

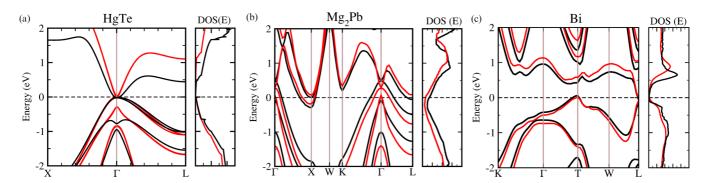


FIG. 3. The band structures (left panels) and density of states (right panels) of HgTe, Mg_2Pb , and Bi representing the three types of semimetals described in Figure 2. Black curves—PBE, red curves—HSE06.

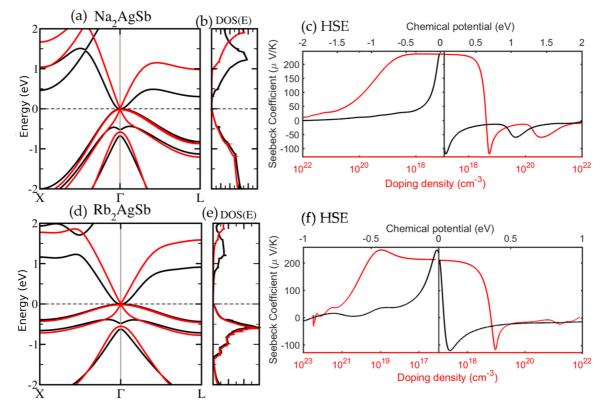


FIG. 4. The band structure, the density of states and the Seebeck coefficient of Na_2AgSb are shown in panels (a), (b), and (c), respectively. Similarly those of Rb_2AgSb are shown in the lower panels of (d), (e), and (f). The black curves in the band structure and DOS plots are PBE results and the red curves are HSE results. The Seebeck coefficients are only reported for HSE results. Red curves are Seebeck coefficient values vs doping concentration and black curves are vs chemical potential. Left side of each Seebeck plot refers to p-type doping and right side to n-type doping.

calculations. For PBE results, where bands were parabolic instead of linear, we refer the reader to the Supplemental Material.

Both materials show large intrinsic Seebeck coefficient values and large intrinsic carrier concentrations. The Seebeck coefficient of Na₂AgSb is larger than 200 μ V/K and interestingly it is insensitive to the changes in the carrier concentration up to $\pm 10^{18}$ cm⁻³. The large value can be associated with the extra parabolic valence band, and the flat Seebeck to the constancy of the slope of the DOS and group velocities in this region. Rb2AgSb is similar. We see this trend more or less for all of our calculated materials, indicating that the coupling between electrical conductivity and the Seebeck coefficient is weaker in the semimetallic samples compared to heavily doped semiconductors. We also emphasize that these large Seebeck values are obtained at relatively large carrier concentrations. Note the carrier concentrations reported in the plots are the Hall type carrier concentration, i.e., the difference between free electron, n, and free holes, p, densities. The actual carrier concentration that determines the electrical conductivity is larger and is the sum of n and p.

Bismuth and antimony are well-known materials and have been the subject of studies for many years [23]. The experimentally measured values for Bi and Sb can provide a good comparison to the theoretical calculations. In addition to Bi and Sb, in Fig. 5 our computational results are compared to reported experimental values of α -Sn, α -HgS, HgSe, HgTe, TiS_2 , TaAs, and PtSb₂. As shown in Fig. 5, and considering there are no fitting parameters, the agreement between theory and experiment is satisfactory.

Several of the samples that we have studied in this work have Seebeck coefficient values larger than 100 μ V/K as shown in Fig. 6. We expect the Seebeck coefficient to be large only when there is a band gap or when there is asymmetry between electron and hole effective masses. To show this we start by using the equation for bipolar Seebeck coefficient under constant relaxation time approximation [75]

$$S = -\frac{k_B}{2q} \left[\frac{\sigma_e - \sigma_h}{\sigma_e + \sigma_h} (\beta E_g + 5) + \beta (\varepsilon_c + \varepsilon_v - 2\mu) \right]$$
(1)

where k_B is the Boltzmann constant, q is the elementary charge, $\beta = (k_B T)^{-1}$, and σ_e and σ_h are electron and hole conductivities. The band gap E_g is defined similar to semiconductors as a difference between the bottom of the conduction band ε_c and the top of the valence band ε_v with the chemical potential μ somewhere in between. The band gap E_g is positive for semiconductors and negative for semimetals where there is band overlap. Its values for different materials studied in this work are listed in Table I. This equation shows that for symmetric bands ($m_e = m_h$) the first term is zero and the Seebeck coefficient grows linearly with the distance of the chemical potential from the middle of the gap. On the other hand when the gap is small compared to k_BT , the Seebeck coefficient strongly depends on the band asymmetry

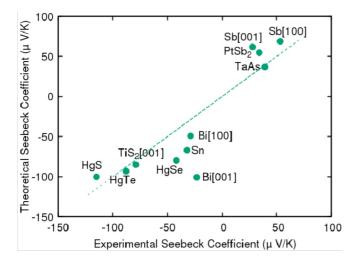


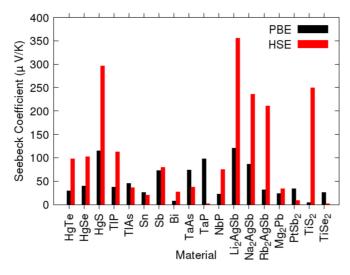
FIG. 5. Computational Seebeck coefficient values calculated in this work using HSE band structures versus experimental Seebeck coefficient values from literature. When available, single crystals in [001] (trigonal) and [100] (binary) directions are compared. Most experimental samples are intrinsic including Bi [66], Sb [67], Sn [68], HgTe [69], PtSb₂ [70], and TaAs [71]. Other samples are n-doped including: α -HgS [72] (10¹⁸ cm⁻³), TiS₂ [73] (8 × 10¹⁸ cm⁻³), and HgSe [74] (10¹⁸ cm⁻³).

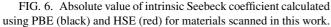
characterized by $\frac{m_e - m_h}{m_e + m_h}$ or more generally on $\frac{\sigma_e - \sigma_h}{\sigma_e + \sigma_h}$. Assuming nondegenerate statistics, constant relaxation time approximation, and intrinsic conditions (n = p), one can simplify Eq. (1) to

$$S = -\frac{k_B}{2q} \left[\frac{\gamma - 1}{\gamma + 1} (\beta E_g + 5) - \frac{3}{2} \ln(\gamma) \right]$$
(2)

where γ is defined as effective mass ratio of holes to electrons (listed in Table I). Note that the condition n = p automatically places the chemical potential at the right place, and we do not need to specify it.

Equation 2 clearly shows that there are two parameters to which the intrinsic Seebeck is sensitive: One is the band gap





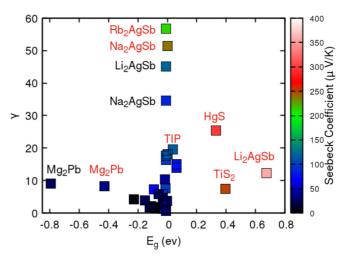


FIG. 7. Absolute value of intrinsic Seebeck coefficient (color bar) as a function of band gap E_g (x axis) and effective mass ratio γ (y axis). Negative band gap refers to overlapping bands. Black and red text correspond to PBE and HSE values, respectively.

and the other is the mass ratio. To demonstrate this, we extract an effective mass from the density of states estimated as the slope of density of states of the electrons (conduction band) and the holes (valence band) with respect to the square root of energy. The absolute value of intrinsic Seebeck coefficient of different materials with respect to the effective mass ratio (effective mass of the holes to that of the electrons) and bandgap energy is plotted in Fig. 7. We see an increasing trend in the Seebeck coefficient values with respect to the mass ratio for semimetals where the band gap is zero or close to zero. There are a few exceptions, namely Na₂AgSb and Rb₂AgSb. In these materials, due to the presence of the Dirac point, the parabolic assumption enabling the extraction of an effective mass is not accurate.

Moreover, the model uses two band nondegenerate statistics that is not accurate when there is an overlap between the bands and when there are more than two bands. Despite these, there is a clear increasing trend of the Seebeck coefficient with respect to the mass ratios.

IV. CONCLUSIONS

In order to validate our hypothesis, that good Seebeck coefficient materials do not necessarily require a band gap, we performed first principles DFT calculations to scan among semimetallic materials potential candidates with high Seebeck coefficient. Computed Seebeck values were found to be in agreement with experimental results when the latter were available. Besides the increase in the intrinsic Seebeck as a function of band gap, an increase with the ratio of hole to electron effective mass is also observed. It is shown that materials with no band gap but with large band asymmetry can still have large Seebeck coefficient values comparable to those of heavily doped semiconductors. The advantage of semimetals is that doping is not needed and therefore mobilities are usually high. Furthermore, we observed that the Seebeck coefficient values of semimetals were in many cases insensitive to carrier concentration in a wide range around the intrinsic density (see Supplemental Material for details). Therefore the coupling between the Seebeck coefficient and the electrical conductivity is weaker in semimetals compared to semiconductors, allowing for simpler optimization of thermoelectric properties. Many of the studied semimetals including Na₂AgSb, Rb₂AgSb,TIP, TaP, and HgSe showed Seebeck coefficient values close to or larger than 100 μ V/K.

Due to relatively high intrinsic carrier concentration and, simultaneously, high mobility, in the absence of doping, these semimetals may show high thermoelectric power factor val-

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ues. The ones with heavy atoms are good candidates for high zT materials. This work paves the way for finding new materials with superior thermoelectric properties among a new class of relatively unexplored materials, namely semimetals.

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